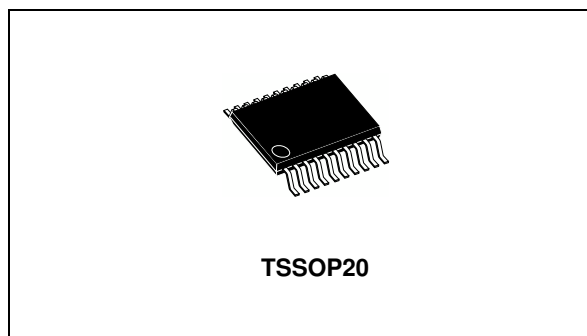


8-bit dual supply 1.71 V to 5.5 V level translator with I/O $V_{CC} \pm 15$ kV ESD protection

Datasheet - production data



Description

The ST2378E device is an 8-bit, dual supply, bidirectional level translator with ± 15 kV ESD protection on I/Os at V_{CC} side. It is designed to interface data transfer between low voltage ASICs/PLDs and higher voltage systems. Externally applied voltage, V_{CC} and V_L , set logic levels at both sides with the range specified as $1.71 \text{ V} \leq V_L \leq 5.5 \text{ V}$ and $V_L \leq V_{CC} \leq 5.5 \text{ V}$. For proper operation, V_{CC} should be set higher than V_L .

Utilizing a transmission-gate-based design, this device allows bidirectional asynchronous data transfer, which means each channel is allowed to have either V_{CC} to V_L or V_L to V_{CC} data transfer direction independently and no direction pin is required. The ST2378E device operates at a guaranteed data rate of 13 Mbps over the entire specified operating voltage range.

Among the other features, the OE pin allows disable mode operation whereby current consumption is reduced to less than 1 μA .

Features

- High speed
 - $t_{PD} = 15 \text{ ns}$ (max.) at $T_A = 85^\circ\text{C}$
 - $V_L = 1.8 \text{ V}$
 - $V_{CC} = 5.5 \text{ V}$
- Guaranteed data rate
 - 13 Mbps ($1.8 \text{ V} \leq V_L \leq V_{CC} \leq 5.5 \text{ V}$)
- Low power dissipation
 - $I_{TS-VL} = I_{TS-VCC} = 1 \mu\text{A}$ (max.) at $T_A = 85^\circ\text{C}$
 - $I_{QVL} = 100 \mu\text{A}$ (max.) at $T_A = 85^\circ\text{C}$
 - $I_{QCC} = 10 \mu\text{A}$ (max.) at $T_A = 85^\circ\text{C}$
- Output impedance
 - $|I_{OHA}| = 20 \mu\text{A}$ (min.) at $V_L = 1.8 \text{ V}$; $V_{CC} = 5.5 \text{ V}$
 - $I_{OLA} = 1.0 \mu\text{A}$ (min.) at $V_L = 1.8 \text{ V}$; $V_{CC} = 5.5 \text{ V}$
- Bidirectional level translation
- Totem pole and open drain driving for I²C communications
- 5 V tolerant on enable pin
- Wide operating voltage range
 - V_L (opr.) = 1.71 V to V_{CC}
 - V_{CC} (opr.) = 1.71 V to 5.5 V
- ESD performance
- HBM > 15 kV ESD protection on I/O V_{CC} lines
- TSSOP package

Table 1. Device summary

Part number	Temp. range (°C)	Package	Marking
ST2378ETTR	-40 to 85	TSSOP20	ST2378E

Contents

1	Block diagram	3
2	Pin settings	4
2.1	Pin connection	4
2.2	Pin description	4
3	Electrical data	5
3.1	Maximum ratings	5
3.2	Recommended operating conditions	5
4	Electrical characteristics	6
5	Test circuit	11
6	Waveforms	12
7	Package information	14
7.1	TSSOP20 package information	15
7.2	TSSOP20 packing information	16
8	Revision history	17

1 Block diagram

Figure 1. Block diagram

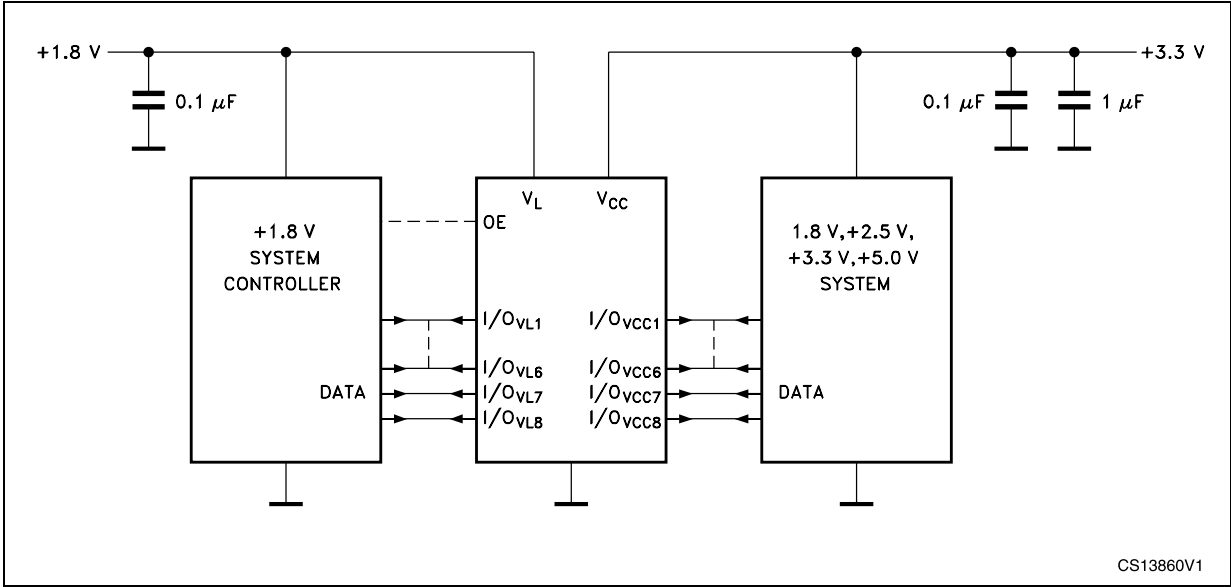
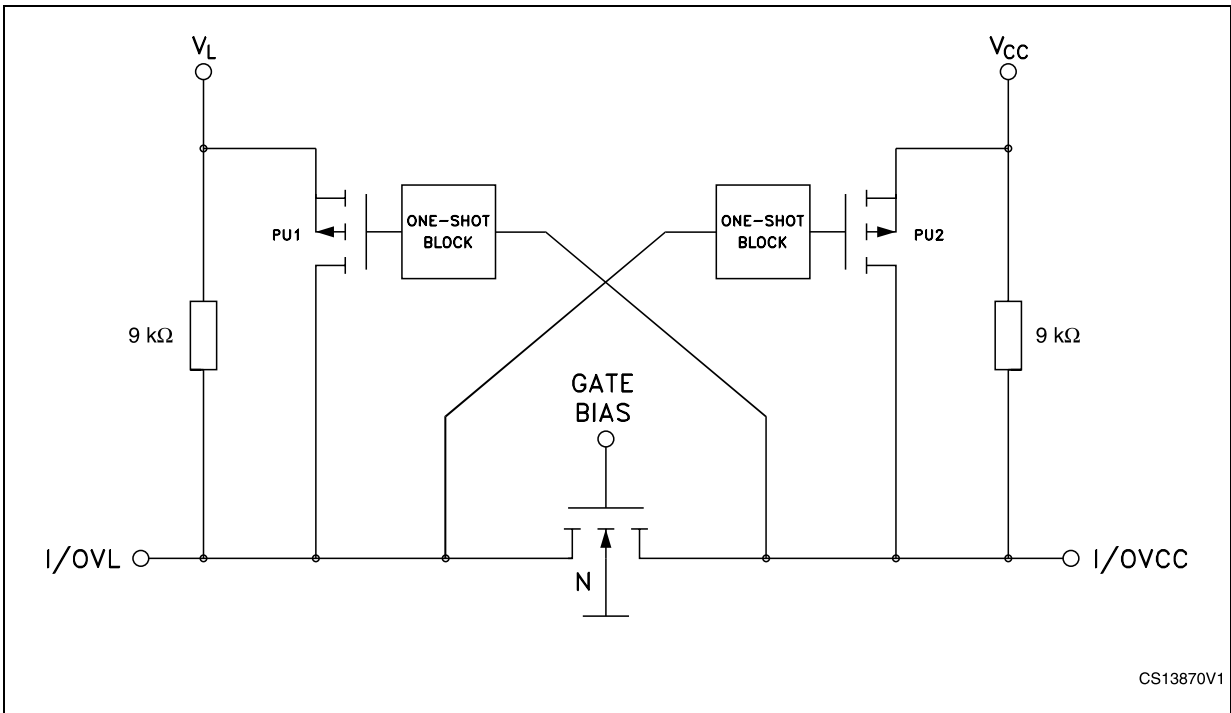


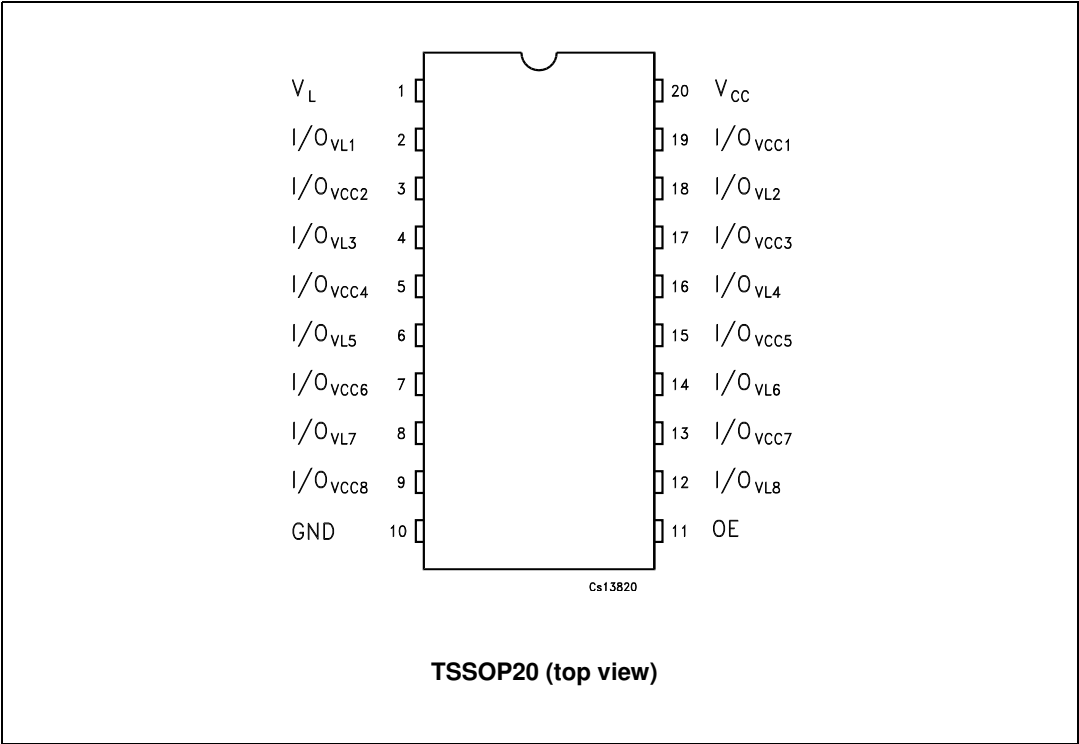
Figure 2. Functional diagram (1 I/O line)



2 Pin settings

2.1 Pin connection

Figure 3. Pin connection



2.2 Pin description

Table 2. Pin description

TSSOP20 pin N°	Symbol	Name and function
2, 18, 4, 16, 6, 14, 8, 12	I/O _{VL1} to I/O _{VL8}	Data inputs/outputs
19, 3, 17, 5, 15, 7, 13, 9	I/O _{VCC1} to I/O _{VCC8}	Data inputs/outputs
11	OE	Output enable inputs
10	GND	Ground (0 V)
1	V _L	Positive supply voltage
20	V _{CC}	Positive supply voltage

3 Electrical data

3.1 Maximum ratings

Table 3. Absolute maximum rating

Symbol	Parameter	Value	Unit
V_L	Supply voltage	-0.3 to V_{CC}	V
V_{CC}	Supply voltage	-0.3 to +7.0	V
V_{OE}	DC control input voltage	-0.3 to +7.0	V
$V_{I/OVL}$	DC I/O_{VL} input voltage (OE = GND or V_L)	-0.3 to $V_L + 0.3$	V
$V_{I/OVCC}$	DC I/O_{VCC} input voltage (OE = GND or V_L)	-0.3 to $V_{CC} + 0.3$	V
I_{IK}	DC input diode current (OE control pin)	- 20	mA
I_{IOVL}	DC output current	± 25	mA
I_{IOVCC}	DC output current	± 25	mA
I_{SCTOUT}	Short-circuit duration I/O_{VL} , I/O_{VCC} driven from 40 mA source	Continuous	mA
I_{CCB}	DC V_{CC} or ground current	± 100	mA
P_d	Power dissipation ⁽¹⁾	500	mW
T_{stg}	Storage temperature	-65 to +150	°C
T_L	Lead temperature (10 sec.)	300	°C

1. 500 mW: $\cong$ 65 °C derated to 300 mW by 10 mW/°C: 65 °C to 85 °C.

3.2 Recommended operating conditions

Table 4. Recommended operating conditions

Symbol	Parameter	Value	Unit
V_L	Supply voltage	1.71 to V_{CC}	V
V_{CC}	Supply voltage	1.71 to 5.5	V
V_I	Input voltage (OE output enable pin, V_L power supply referred)	0 to 5.5	V
$V_{I/OVL}$	I/O_{VL} voltage	0 to V_L	V
$V_{I/OVCC}$	I/O_{VCC} voltage	0 to V_{CC}	V
T_{op}	Operating temperature	-40 to 85	°C
dt/dv	Input rise and fall time (OE control pin) ⁽¹⁾	0 to 10	ns/V
dt/dv	Input rise and fall time ⁽²⁾	$1.71 < V_L < V_{CC} < 5 \text{ V}$	0 to 10
		$V_{CC} = V_L = 5 \text{ V}$	0 to 3

1. V_{OE} from 10% V_L to 90% V_L .

2. V_{IOVL} from 10% V_L to 90% V_L ; V_{IOVCC} from 10% V_{CC} to 90% V_{CC} .

4 Electrical characteristics

Table 5. DC specification

Symbol	Parameter	Test condition ⁽¹⁾			Value					Unit
		V _L (V) ⁽²⁾	V _{CC} (V) ⁽²⁾		T _A = 25 °C			-40 to 85 °C		
					Min.	Typ. ⁽³⁾	Max.	Min.	Max.	
V _{IHL}	High level input voltage (I/O _{VL})	1.8	V _L to 5.5		V _L -0.2			V _L -0.2		V
		2.5	V _L to 5.5		0.75 V _L			0.75 V _L		
		3.3	V _L to 5.5		0.75 V _L			0.75 V _L		
		5.0	V _L to 5.5		0.75 V _L			0.75 V _L		
V _{ILL}	Low level input voltage (I/O _{VL})	1.8	V _L to 5.5				0.15		0.15	V
		2.5	V _L to 5.5				0.30		0.30	
		3.3	V _L to 5.5				0.30		0.30	
		5.0	V _L to 5.5				0.30		0.30	
V _{IHC}	High level input voltage (I/O _{VCC})	1.8	V _L to 5.5		V _L -0.2			V _L -0.2		V
		2.5	V _L to 5.5		0.75 V _{CC}			0.75 V _{CC}		
		3.3	V _L to 5.5		0.75 V _{CC}			0.75 V _{CC}		
		5.0	V _L to 5.5		0.75 V _{CC}			0.75 V _{CC}		
V _{ILC}	Low level input voltage (I/O _{VCC})	1.8	V _L to 5.5				0.15		0.15	V
		2.5	V _L to 5.5				0.30		0.30	
		3.3	V _L to 5.5				0.30		0.30	
		5.0	V _L to 5.5				0.30		0.30	
V _{IH-TS}	High level input voltage (OE)	1.8	V _L to 5.5		V _L -0.2			V _L -0.2		V
		2.5	V _L to 5.5		0.75 V _L			0.75 V _L		
		3.3	V _L to 5.5		0.75 V _L			0.75 V _L		
		5.0	V _L to 5.5		0.75 V _L			0.75 V _L		
V _{IL-TS}	Low level input voltage (OE)	1.8	V _L to 5.5				0.15		0.15	V
		2.5	V _L to 5.5				0.25 V _L		0.25 V _L	
		3.3	V _L to 5.5				0.25 V _L		0.25 V _L	
		5.0	V _L to 5.5				0.25 V _L		0.25 V _L	
V _{OHL}	High level output voltage I/O _{VL}	1.8 to 5.5	V _L to 5.5	I _O = -20 μA I/O _{VCC} ≥ V _{CC} -0.2	0.67 V _L			0.67 V _L		V
V _{OLL}	Low level output voltage I/O _{VL}			I _O = 1.0 mA I/O _{VCC} ≤ 0.15 V			0.40		0.40	

Table 5. DC specification (continued)

Symbol	Parameter	Test condition ⁽¹⁾			Value					Unit
		V _L (V) ⁽²⁾	V _{CC} (V) ⁽²⁾		T _A = 25 °C			-40 to 85 °C		
					Min.	Typ. ⁽³⁾	Max.	Min.	Max.	
V _{OHC}	High level output voltage I/O _{VCC}	1.8 to 5.5	V _L to 5.5	I _O = -20 μA I/O _{VL} ≥ V _L -0.2	0.67 V _{CC}			0.67 V _{CC}		V
V _{OLC}	Low level output voltage I/O _{VCC}			I _O = 1.0 mA I/O _{VL} ≤ 0.15 V			0.40		0.40	
I _{TSL}	Control input leakage current (OE)	1.8 to 5.5	V _L to 5.5	V _I = GND or 5.5			1		1	μA
I _{TS-LKG}	High impedance input leakage current (I/O _{VL} , I/O _{VCC})	1.8 to 5.5	V _L to 5.5	OE = GND			1		1	μA
I _{QVCC}	Quiescent supply current V _{CC}	1.8 to 5.5	V _L to 5.5	I/O _{VL} , I/O _{VCC} unconnected		0.1	1		10	μA
I _{QVL}	Quiescent supply current V _L	1.8 to 5.5	V _L to 5.5	I/O _{VL} , I/O _{VCC} unconnected		13	20		100	μA
I _{TS-VL}	High impedance mode quiescent supply current V _L	1.8 to 5.5	V _L to 5.5	OE = GND I/O _{VL} = GND to V _L I/O _{VCC} = GND to V _{CC}			1		1	μA

1. For normal operation, ensure V_L < (V_{CC} + 0.3 V). During power-up, V_L > (V_{CC} + 0.3 V) will not damage the device.
2. Power supply range: V_L, V_{CC} 1.8 V ± 5%, 2.5 ± 0.2 V, 3.3 ± 0.3 V, 5.0 ± 0.5 V.
3. Typical values are referred to T_A = 25 °C.

Table 6. AC electrical characteristics (totem pole driving)

Symbol	Parameter		Test condition ⁽¹⁾		Value			Unit	
			C _L = 15 pF, t _r = t _f ≤ 6 ns ⁽²⁾ Driver output R _T ≤ 50 Ω		-40 to +85 °C				
V _L (V) ⁽³⁾	V _{CC} (V) ⁽³⁾	Min.	Typ. ⁽⁴⁾	Max.					
t _{RVCC}	Rise time I/O _{VCC} ⁽⁵⁾		1.8	1.8		11	15	ns	
			1.8	2.5		11	15		
			1.8	3.3		10	15		
			1.8	5.0		9	15		
			2.5	3.3		8	15		
t _{FVCC}	Fall time I/O _{VCC} ⁽⁵⁾		1.8	1.8		6	15	ns	
			1.8	2.5		7	15		
			1.8	3.3		8	15		
			1.8	5.0		10	15		
			2.5	3.3		6	15		
t _{RVL}	Rise time I/O _{VL} ⁽⁵⁾		1.8	1.8		12	15	ns	
			1.8	2.5		10	15		
			1.8	3.3		9	15		
			1.8	5.0		10	15		
			2.5	3.3		7	15		
t _{FVL}	Fall time I/O _{VL} ⁽⁵⁾		1.8	1.8		7	15	ns	
			1.8	2.5		6	15		
			1.8	3.3		6	15		
			1.8	5.0		7	15		
			2.5	3.3		4	15		
t _{IOVL-VCC}	Propagation delay time ⁽⁶⁾ I/O _{VL-LH} to I/O _{VCC-LH} I/O _{VL-HL} to I/O _{VCC-HL}		t _{PLH}	1.8	1.8		6	15	ns
				1.8	2.5		7	15	
				1.8	3.3		7	15	
				1.8	5.0		7	15	
				2.5	3.3		4	15	
			t _{PHL}	1.8	1.8		5	15	
				1.8	2.5		5	15	
				1.8	3.3		6	15	
				1.8	5.0		8	15	
				2.5	3.3		4	15	

Table 6. AC electrical characteristics (totem pole driving) (continued)

Symbol	Parameter		Test condition ⁽¹⁾		Value			Unit
			C_L = 15 pF, t_r = t_f ≤ 6 ns⁽²⁾ Driver output R_T ≤ 50 Ω		-40 to +85 °C			
			V _L (V) ⁽³⁾	V _{CC} (V) ⁽³⁾	Min.	Typ. ⁽⁴⁾	Max.	
t _{IOVCC-VL}	Propagation delay time ⁽⁶⁾ I/O _{VCC-LH} to I/O _{VL-LH} I/O _{VCC-HL} to I/O _{VL-HL}	t _{PLH}	1.8	1.8		2	15	ns
			1.8	2.5		2	15	
			1.8	3.3		2	15	
			1.8	5.0		2	15	
			2.5	3.3		2	15	
		t _{PHL}	1.8	1.8		5	15	
			1.8	2.5		5	15	
			1.8	3.3		5	15	
			1.8	5.0		6	15	
			2.5	3.3		4	15	
t _{PZL} t _{PZH} t _{PLZ} t _{PZL}	Output enable and disable time	1.8	1.8		60	80	ns	
		1.8	5.0		150	200		
t _{OSLH} t _{OSHL}	Channel to channel skew time ^{(7),(8)}	1.8	1.8		0.1	1	ns	
		1.8	5.0		0.5	1		
DR	Maximum data rate		1.8 to 5.0	V _L to 5.0	13			Mbps

- For normal operation, ensure $V_L < (V_{CC} + 0.3 \text{ V})$. During power-up, $V_L > (V_{CC} + 0.3 \text{ V})$ will not damage the device.
- For $V_{CC} = V_L = 1.8 \text{ V}$, $t_r = t_f \leq 4 \text{ ns}$.
- Power supply range: V_L , V_{CC} $1.8 \text{ V} \pm 5\%$, $2.5 \pm 0.2 \text{ V}$, $3.3 \pm 0.3 \text{ V}$, $5.0 \pm 0.5 \text{ V}$.
- Typical values are referred to $T_A = 25 \text{ }^\circ\text{C}$.
- Rise time: 10% to 90%, fall time 90% to 10%.
- Propagation delay time: 50% to 50%.
- Skew is defined as the absolute value of the difference between the actual propagation delay for any two outputs of the same device switching in the same direction, either HIGH or LOW ($t_{OSLH} = |t_{PLHm} - t_{PLHn}|$, $t_{OSHL} = |t_{PHLm} - t_{PHLn}|$).
- Each translator equally loaded; parameter guaranteed by design.

Table 7. AC characteristic (open drain driving)

Symbol	Parameter		Test condition ⁽¹⁾		Value			Unit	
			C_L = 15 pF, t_r = t_f ≤ 6 ns⁽²⁾ Driver output R_T ≤ 50 Ω		-40 to +85 °C				
			V _L (V) ⁽³⁾	V _{CC} (V) ⁽³⁾	Min.	Typ. ⁽⁴⁾	Max.		
t _{RVCC}	Rise time I/O _{VCC} ⁽⁵⁾		1.8	1.8		210	300	ns	
			1.8	5.0		59	150		
t _{FVCC}	Fall time I/O _{VCC} ⁽⁵⁾		1.8	1.8		12	30	ns	
			1.8	5.0		20	30		
t _{RVL}	Rise time I/O _{VL} ⁽⁵⁾		1.8	1.8		210	300	ns	
			1.8	5.0		96	150		
t _{FVL}	Fall time I/O _{VL} ⁽⁵⁾		1.8	1.8		11	30	ns	
			1.8	5.0		11	30		
t _{IOVL-VCC}	Propagation delay time ⁽⁶⁾ I/O _{VL-LH} to I/O _{VCC-LH} I/O _{VL-HL} to I/O _{VCC-HL}		t _{PLH}	1.8	1.8		210	300	ns
				1.8	5.0		100	150	
			t _{PHL}	1.8	1.8		7	20	
				1.8	5.0		14	20	
t _{IOVCC-VL}	Propagation delay time ⁽⁶⁾ I/O _{VCC-LH} to I/O _{VL-LH} I/O _{VCC-HL} to I/O _{VL-HL}		t _{PLH}	1.8	1.8		210	300	ns
				1.8	5.0		57	150	
			t _{PHL}	1.8	1.8		7	20	
				1.8	5.0		8	20	
t _{PZL} t _{PZH} t _{PLZ} t _{PZL}	Output enable and disable time		1.8	1.8		60	80	ns	
			1.8	5.0		150	200		
t _{OSLH} t _{OSHL}	Channel to channel skew time ^{(7), (8)}		1.8	1.8		10	20	ns	
			1.8	5.0		2	10		
DR	Maximum data rate		1.8 to 5.0	V _L to 5.0	800			kbps	

1. For normal operation, ensure $V_L < (V_{CC} + 0.3 \text{ V})$. During power-up, $V_L > (V_{CC} + 0.3 \text{ V})$ will not damage the device.

2. For $V_{CC} = V_L = 1.8 \text{ V}$, $t_r = t_f \leq 4 \text{ ns}$.

3. Power supply range: V_L , V_{CC} $1.8 \text{ V} \pm 5\%$, $2.5 \pm 0.2 \text{ V}$, $3.3 \pm 0.3 \text{ V}$, $5.0 \pm 0.5 \text{ V}$.

4. Typical values are referred to $T_A = 25 \text{ °C}$.

5. Rise time: 10% to 90%, fall time 90% to 10%.

6. Propagation delay time: 50% to 50%.

7. Skew is defined as the absolute value of the difference between the actual propagation delay for any two outputs of the same device switching in the same direction, either HIGH or LOW ($t_{OSLH} = |t_{PLHm} - t_{PLHn}|$, $t_{OSHL} = |t_{PHLm} - t_{PHLn}|$).

8. Each translator equally loaded; parameter guaranteed by design.

5 Test circuit

Figure 4. Test circuit

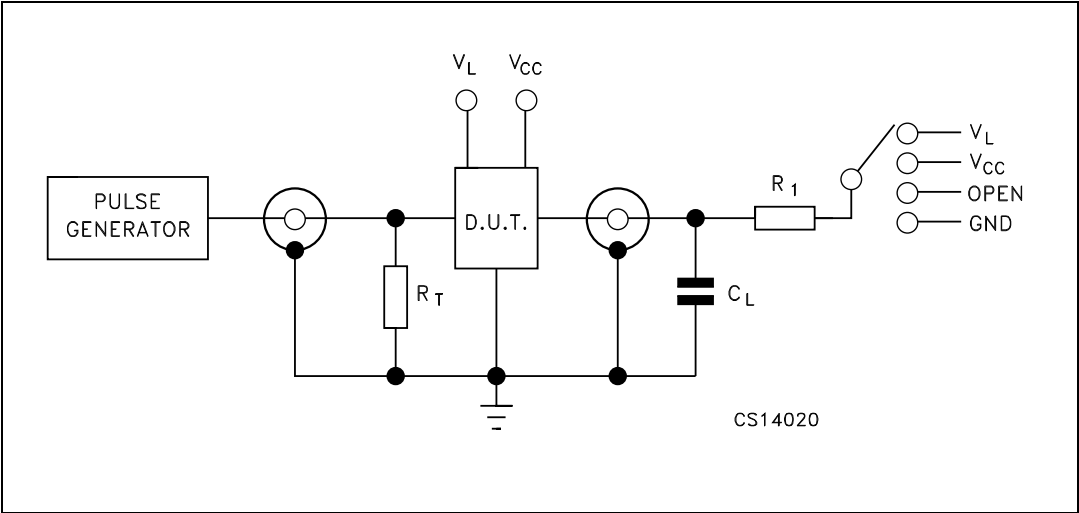


Table 8. Test circuit switches

Test	Switch		
	Driving I/O _{V_L}	Driving I/O _{V_{CC}}	Open drain driving
t_{PLH} , t_{PHL}	Open	Open	Open
t_{PZL} , t_{PLZ}	V _{CC}	V _L	-
t_{PZH} , t_{PHZ}	GND	GND	-

Note: $C_L = 15/50$ pF or equivalent (includes jig and probe capacitance).
 $R_1 = 1$ k Ω or equivalent.
 $R_T = Z_{OUT}$ of pulse generator (typically 50 Ω).

Table 9. Truth table

Control pin	Bidirectional input/outputs	
OE	I/O _{V_L}	I/O _{V_{CC}}
H ⁽¹⁾	H ⁽¹⁾	H ⁽²⁾
H ⁽¹⁾	L	L
L	Z	Z

1. High level V_L power supply referred.
2. High level V_{CC} power supply referred.

Note: X = do not care; Z = high impedance.

6 Waveforms

Table 10. Waveform symbol value

Symbol	Driving I/O _{VL}		Driving I/O _{VCC}	
	$1.8\text{ V} \leq V_L \leq V_{CC} \leq 2.5\text{ V}$	$3.3\text{ V} \leq V_L \leq V_{CC} \leq 5.0\text{ V}$	$1.8\text{ V} \leq V_L \leq V_{CC} \leq 2.5\text{ V}$	$3.3\text{ V} \leq V_L \leq V_{CC} \leq 5.0\text{ V}$
V_{IH}	V_L	V_L	V_{CC}	V_{CC}
V_{IM}	$50\% V_L$	$50\% V_L$	$50\% V_{CC}$	$50\% V_{CC}$
V_{OM}	$50\% V_{CC}$	$50\% V_{CC}$	$50\% V_{CC}$	$50\% V_{CC}$
V_X	$V_{OL} + 0.15\text{ V}$	$V_{OL} + 0.3\text{ V}$	$V_{OL} + 0.15\text{ V}$	$V_{OL} + 0.3\text{ V}$
V_Y	$V_{OH} - 0.15\text{ V}$	$V_{OH} - 0.3\text{ V}$	$V_{OH} - 0.15\text{ V}$	$V_{OH} - 0.3\text{ V}$

Figure 5. Waveform - propagation delay ($f = 1\text{ MHz}$; 50% duty cycle)

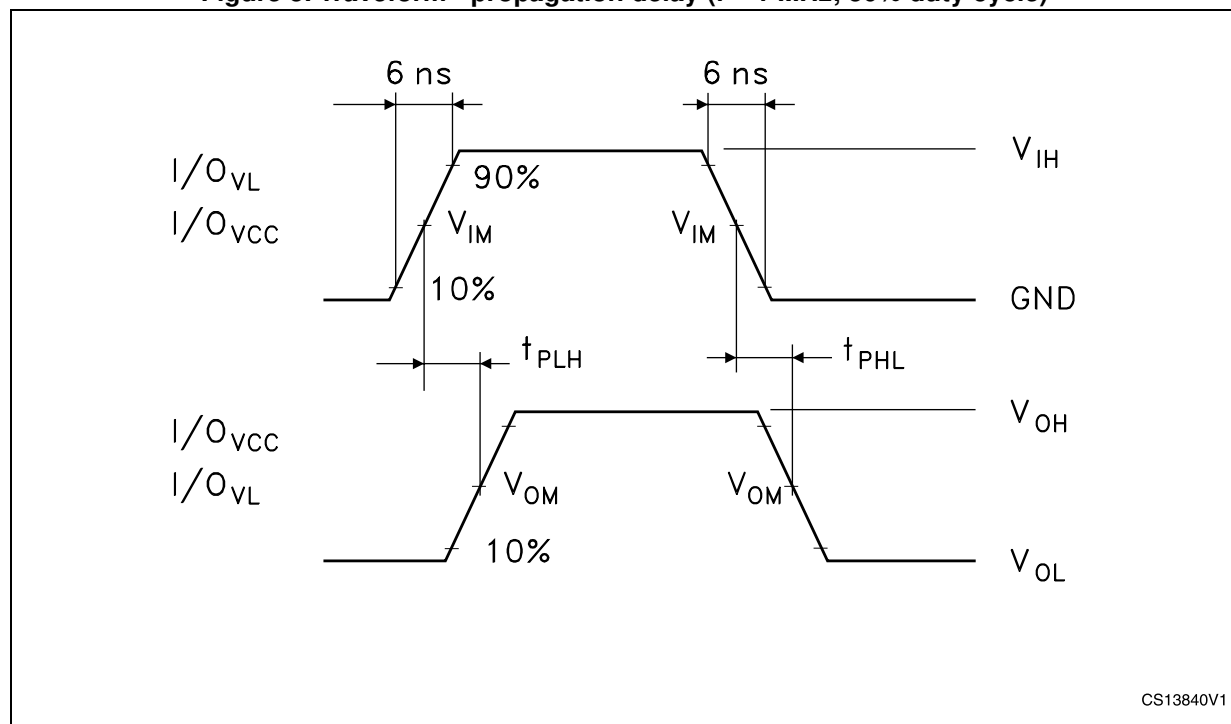
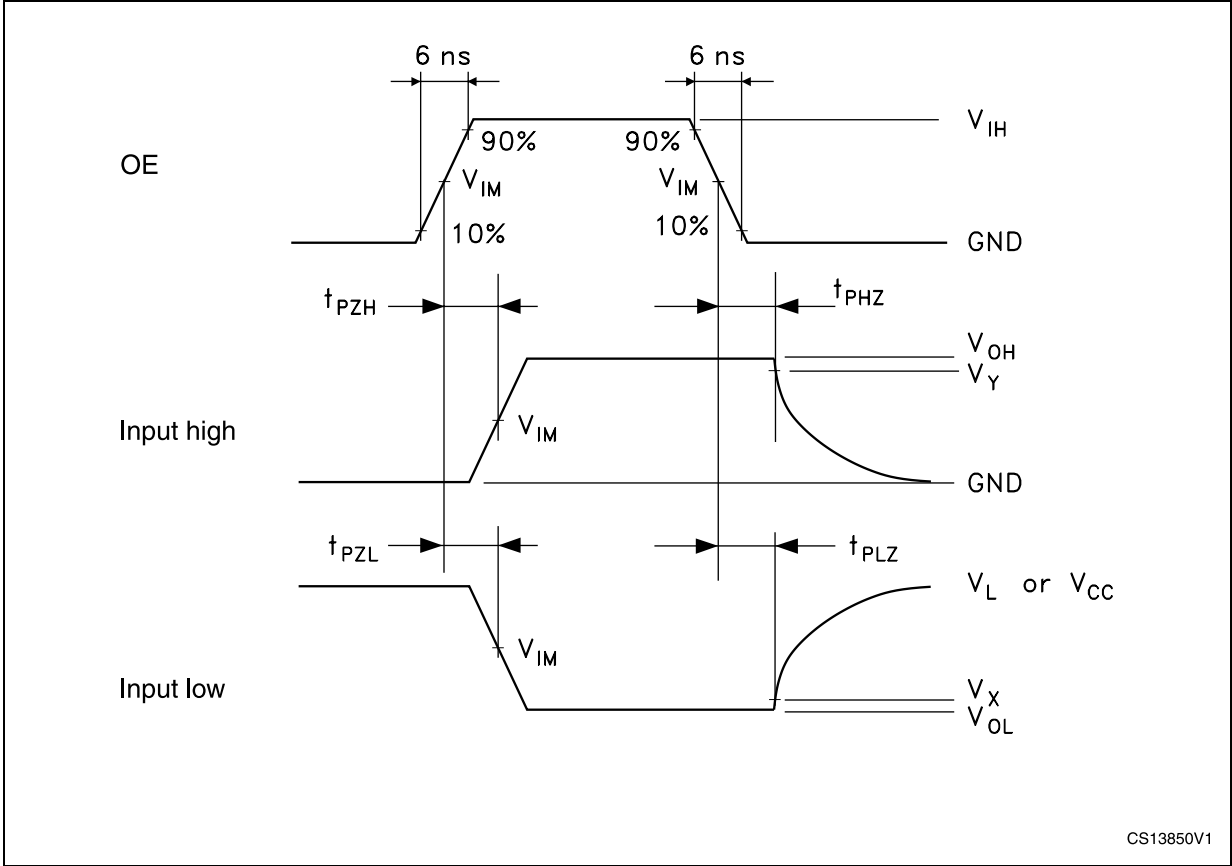


Figure 6. Waveform - output enable and disable time (f = 1 MHz; 50% duty cycle)



7 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

7.1 TSSOP20 package information

Figure 7. TSSOP20 package outline

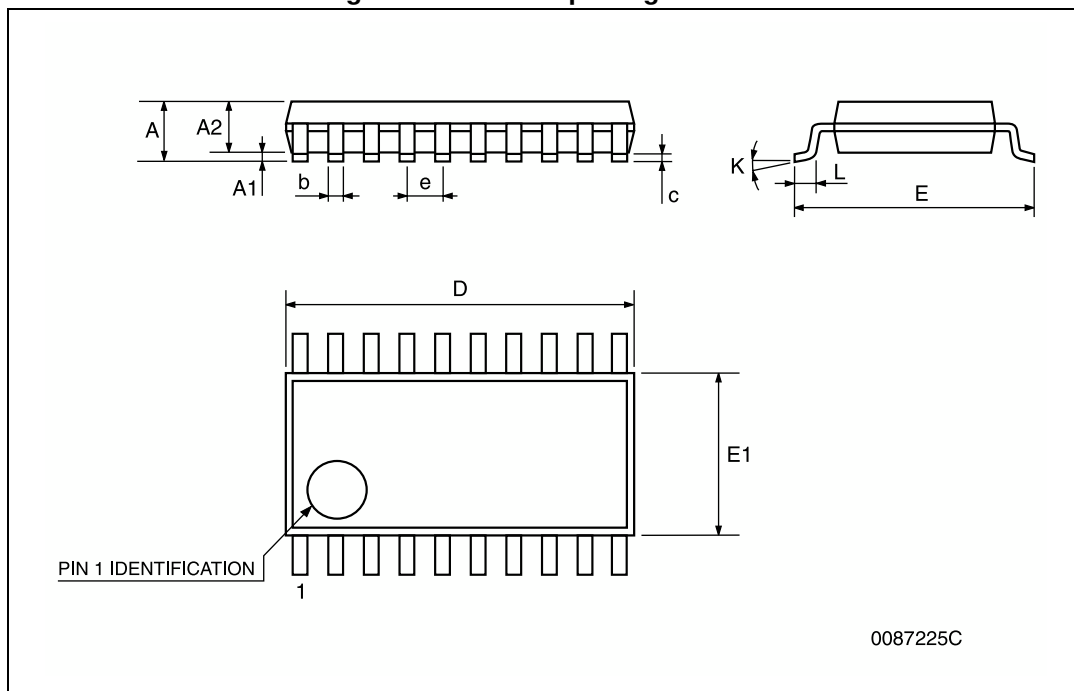
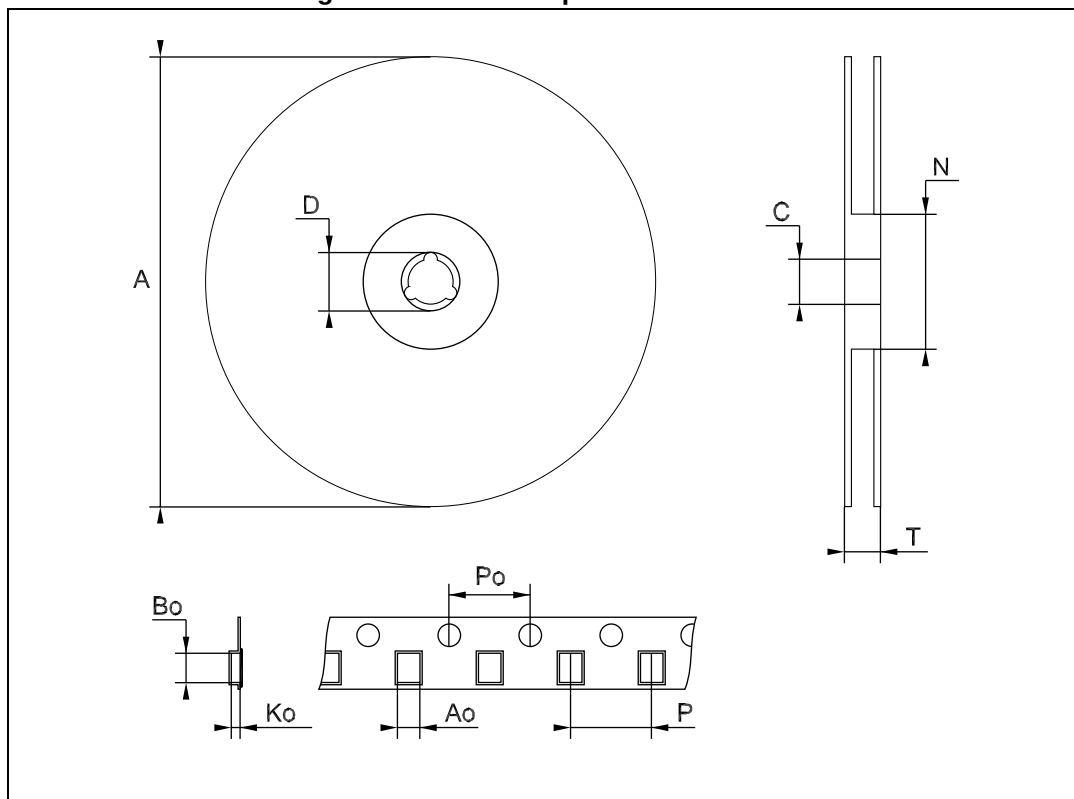


Table 11. TSSOP20 package mechanical data

Symbol	Dimensions					
	mm			inch		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0079
D	6.4	6.5	6.6	0.252	0.256	0.260
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030

7.2 TSSOP20 packing information

Figure 8. TSSOP20 tape and reel outline



1. Drawing not to scale.

Table 12. TSSOP20 tape and reel mechanical data

Symbol	Dimensions					
	mm			inch		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao	6.8		7	0.268		0.276
Bo	6.9		7.1	0.272		0.280
Ko	1.7		1.9	0.067		0.075
Po	3.9		4.1	0.153		0.161
P	11.9		12.1	0.468		0.476

8 Revision history

Table 13. Document revision history

Date	Revision	Changes
10-Apr-2006	1	Initial release.
18-Sep-2012	2	Updated Figure 2 (added resistor values). Updated notes and cross-references of the notes below Table 5 to Table 7, replaced t_{FCC} by t_{FVCC} in Table 6 and Table 7. Updated ECOPACK text in Section 7., reformatted Section 7 (added Table 11 to Table 14, moved note below Figure 8 and Figure 10). Minor corrections throughout document.
18-May-2015	3	Added Table 1: Device summary. Revised presentation of Section 7: Package information. Minor textual updates.
04-Oct-2024	4	Removed the part number ST2378EBJR (flip-chip package) and all its reference throughout the document.

IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. For additional information about ST trademarks, please refer to www.st.com/trademarks. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2024 STMicroelectronics – All rights reserved